

### 2.0x1.25mm SMD CHIP LED LAMP

Part Number: KP-2012CGCK Green

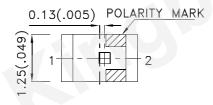
### **Features**

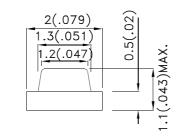
- 2.0mmx1.25mm SMT LED,1.1mm thickness.
- Low power consumption.
- Wide viewing angle.
- Ideal for backlight and indicator.
- Package : 2000pcs / reel.
- Moisture sensitivity level : level 3.
- RoHS compliant.

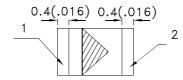
## **Description**

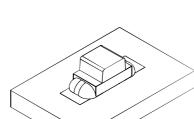
The Green source color devices are made with AlGalnP on GaAs substrate Light Emitting Diode.

## **Package Dimensions**









- 1. All dimensions are in millimeters (inches).
  2. Tolerance is ±0.1(0.004") unless otherwise noted.
- 3. The specifications, characteristics and technical data described in the datasheet are subject to change without prior notice.

  4. The device has a single mounting surface. The device must be mounted according to the specifications.

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## **Selection Guide**

Part No.	Dice	Lens Type	lv (mcd) [2] @ 20mA		Viewing Angle [1]
		-	Min.	Тур.	201/2
KP-2012CGCK	Green (AlGaInP)	Water Clear	20	50	120°

### Notes:

- 1.  $\theta$ 1/2 is the angle from optical centerline where the luminous intensity is 1/2 of the optical peak value.
- Luminous intensity/ luminous Flux: +/-15%.
   Luminous intensity value is traceable to the CIE127-2007 compliant national standards.

## Electrical / Optical Characteristics at TA=25°C

Symbol	Parameter	Device	Тур.	Max.	Units	Test Conditions
λpeak	Peak Wavelength	Green	574		nm	IF=20mA
λD [1]	Dominant Wavelength	Green	570		nm	IF=20mA
Δλ1/2	Spectral Line Half-width	Green	20		nm	IF=20mA
С	Capacitance	Green	15		pF	VF=0V;f=1MHz
VF [2]	Forward Voltage	Green	2.1	2.5	V	IF=20mA
lr	Reverse Current	Green		10	uA	VR=5V

## Notes:

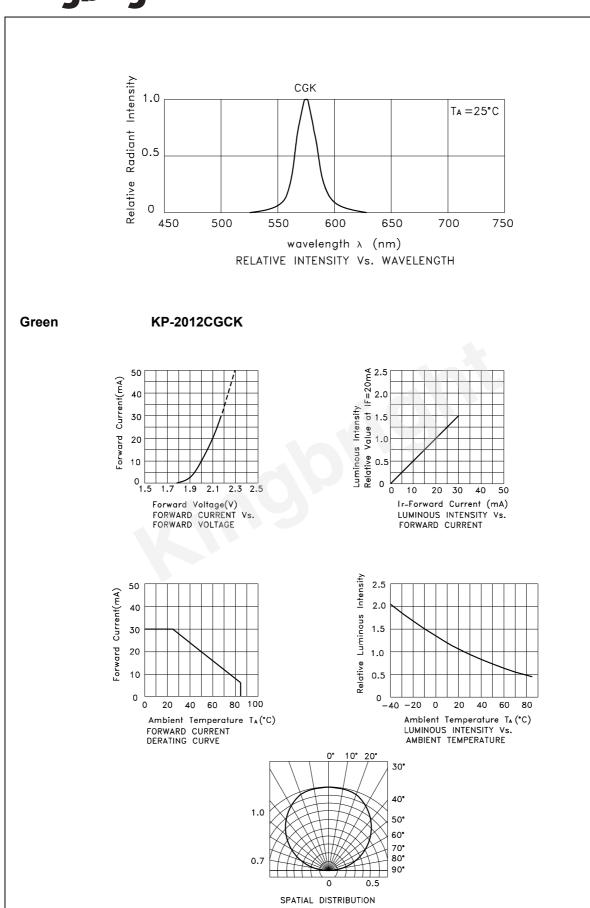
- 1.Wavelength: +/-1nm. 2. Forward Voltage: +/-0.1V.
- 3. Wavelength value is traceable to the CIE127-2007 compliant national standards.

## Absolute Maximum Ratings at TA=25°C

7. 100 or 1 of 1					
Parameter	Green				
Power dissipation	75	mW			
DC Forward Current	30	mA			
Peak Forward Current [1]	150	mA			
Reverse Voltage	5	V			
Operating Temperature	-40°C To +85°C				
Storage Temperature	-40°C To +85°C				

Note: 1. 1/10 Duty Cycle, 0.1ms Pulse Width.

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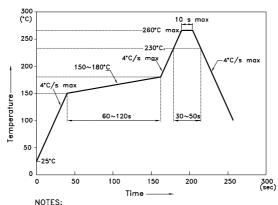
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Reflow soldering is recommended and the soldering profile is shown below. Other soldering methods are not recommended as they might cause damage to the product.

Reflow Soldering Profile For Lead-free SMT Process.



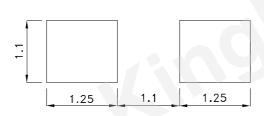
- NOTES:

  1.We recommend the reflow temperature 245°C(+/-5°C). The maximum soldering temperature should be limited to 260°C.

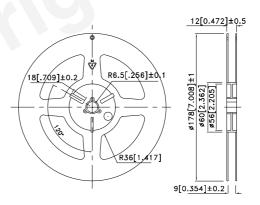
  2.Don't cause stress to the epoxy resin while it is exposed to high temperature.

  3.Number of reflow process shall be 2 times or less.

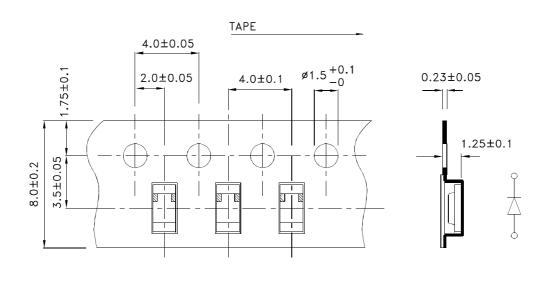
## **Recommended Soldering Pattern** (Units: mm; Tolerance: ± 0.1)



## **Reel Dimension**



**Tape Dimensions** (Units: mm)



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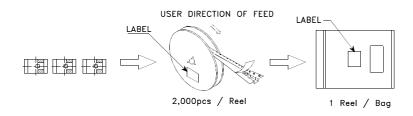
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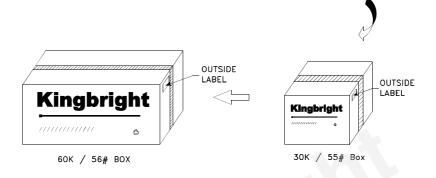
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**PACKING & LABEL SPECIFICATIONS** 

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